



YEA SHIN TECHNOLOGY CO., LTD

ES1A THRU ES1J

SURFACE MOUNT SUPERFAST RECTIFIER

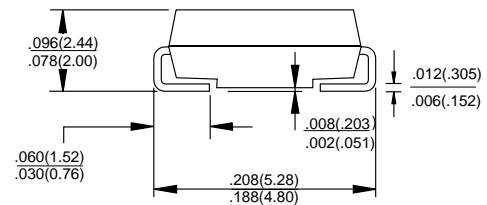
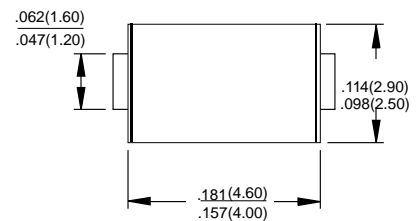
VOLTAGE - 50 to 600 Volts CURRENT - 1.0 Ampere



FEATURES

- For surface mounted applications
- Low profile package
- Built-in strain relief
- Easy pick and place
- Superfast recovery times for high efficiency
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Glass passivated junction
- High temperature soldering : 260°C / 10 seconds at terminals
- Pb free product at available : 99% Sn above meet RoHS environment substance directive request

SMA/DO-214AC Unit:inch(mm)



MECHANICAL DATA

- Case: JEDEC DO-214AC molded plastic
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Indicated by cathode band

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave 60Hz resistive or inductive load.

For capacitive load, derate current by 20%.

	SYMBOLS	ES1A	ES1B	ES1C	ES1D	ES1E	ES1G	ES1J	UNITS
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	150	200	300	400	600	Volts
Maximum RMS Voltage	VRMS	35	70	105	140	210	280	420	Volts
Maximum DC Blocking Voltage	VDC	50	100	150	200	300	400	600	Volts
Maximum Average Forward Rect ified Current , at TL=120 °C	I(AV)	1.0							Amps
Peak Forward Surge Current 8.3ms single half sinewave superimposed on rated load(JEDEC method)	IFSM	30.0							Amps
Maximum Instantaneous Forward Voltage at 1.0A	VF	0.95				1.25		1.7	Volts
Maximum DC Reverse Current TA=25 °C	IR	5.0							uA
At Rated DC Blocking Voltage TA=100°C		100							
Maximum Reverse Recovery Time (Note 1)	TRR	35.0							nS
Typical Junction capacitance (Note 2)	Cj	10.0							pF
Typical Thermal Resistance (Note 3)	RθJC	60							°C /W
Operating and Storage Temperature Range	Tj,Tstg	-55to +150							°C

NOTES:

1. Reverse Recovery Test Conditions: IF=0.5A, IR=1.0A, Irr=0.25A
2. Measured at 1 MHz and Applied reverse voltage of 4.0 volts
3. Device mounted on FR-4 substrate, 1" * 1", 2oz, single-sided, PC boards with 0.1" * 0.15" copper pad.

DEVICE CHARACTERISTICS

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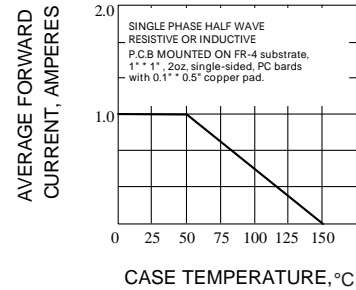
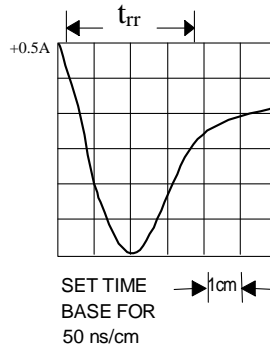
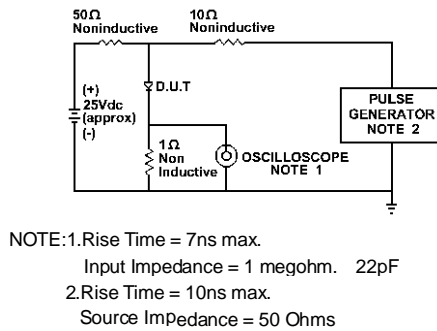


Fig. 1-REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

Fig. 2-MAXIMUM AVERAGE FORWARD CURRENT RATING

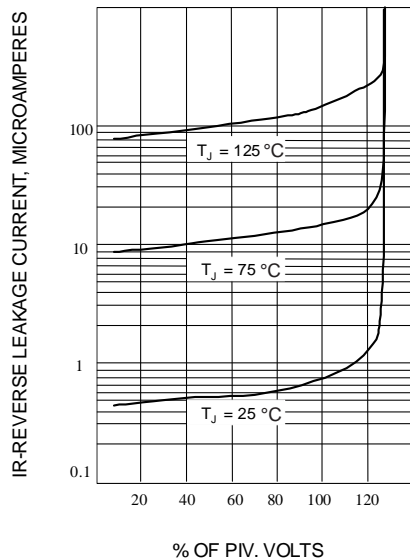


Fig. 3-TYPICAL REVERSE CHARACTERISTICS

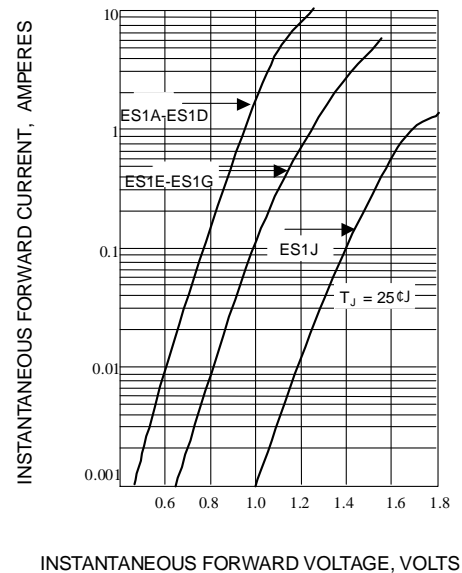


Fig. 4-TYPICAL FORWARD CHARACTERISTICS

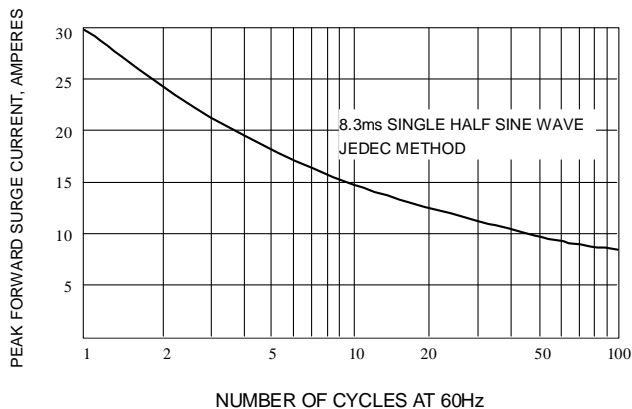


Fig. 5-MAXIMUM NON-REPETITIVE SURGE CURRENT

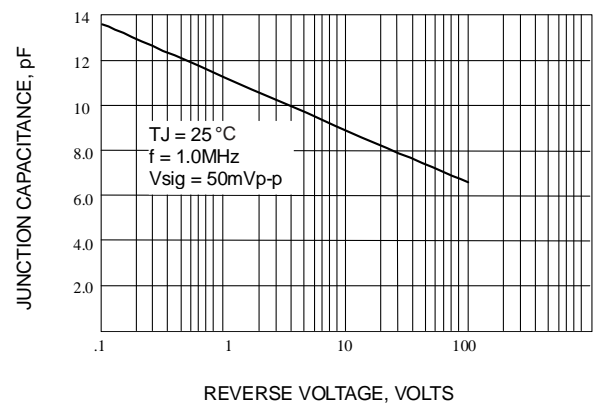


Fig. 6-TYPICAL JUNCTION CAPACITANCE